

15-OUTPUT DB1900Z LOW-POWER DERIVATIVE

9ZXL1530

Description

The 9ZXL1530 is a 15-output version of the Intel DB1900Z Differential Buffer utilizing Low-Power HCSL (LP-HCSL) outputs to reduce power consumption more than 50% from the original IDT9ZX21501. It is suitable for PCI-Express Gen1/2/3 or QPI/UPI applications, and uses a fixed external feedback to maintain low drift for demanding QPI/UPI applications.

Recommended Application

Buffer for Romley, Grantley and Purley Servers

Key Specifications

- Cycle-to-cycle jitter: < 50ps
- Output-to-output skew: <65ps
- Input-to-output delay: Fixed at 0 ps
- Input-to-output delay variation: <50ps
- Phase jitter: PCIe Gen3 < 1ps rms
- Phase jitter: QPI 9.6GB/s < 0.2ps rms

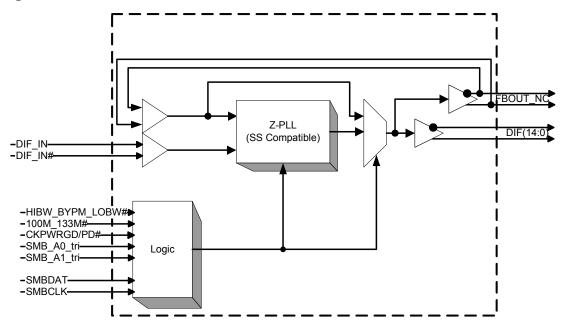
Features/Benefits

- · Fixed feedback path; Ops input-to-output delay
- 9 Selectable SMBus addresses; Multiple devices can share same SMBus segment
- Separate VDDIO for outputs; allows maximum power savings
- PLL or bypass mode; PLL can dejitter incoming clock
- Selectable PLL BW; minimizes jitter peaking in downstream PLL's
- Spread spectrum compatible; tracks spreading input clock for EMI reduction
- SMBus Interface; unused outputs can be disabled
- 100MHz & 133.33MHz PLL mode; Legacy QPI/UPI support
- Differential outputs are Low/Low in power down;
 Maximum power savings

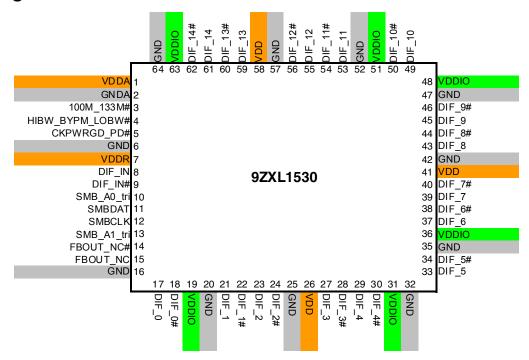
Output Features

• 15 - LP-HCSL Differential Output Pairs

Block Diagram



Pin Configuration



Note: Pins with ^ prefix have internal 120K pullup
Pins with v prefix have internal 120K pulldowm

Power Management Table

Inputs	Control Bits	Oı	utputs		
	DIF_IN/	SMBus	DIF_x/	FBOUT_NC/	PLL State
CKPWRGD_PD#	DIF_IN#	EN bit	DIF_x#	FBOUT_NC#	
0	Χ	X	Low/Low	Low/Low	OFF
1	Running	0	Low/Low	Running	ON
'	rturriing	1	Running	Running	ON

Power Connections

	Description				
VDD	VDDIO	GND	Describiton		
1	2		Analog PLL		
7		6	Analog Input		
26, 41, 58	19,31,36,48,51 ,63	16,20,25,32,3			
		5,42,47,52,57	DIF clocks		
	,63	,64			

Functionality at Power-up (PLL mode)

100M_133M#	DIF_IN (MHz)	DIFx (MHz)		
1	100.00	DIF_IN		
0	133.33	DIF_IN		

PLL Operating Mode

HiBW_BypM_LoBW#	Byte0, bit (7:6)
Low (PLL Low BW)	00
Mid (Bypass)	01
High (PLL High BW)	11

NOTE: PLL is off in Bypass mode

Tri-Level Input Thresholds

Level	Voltage
Low	<0.8V
Mid	1.2 <vin<1.8v< td=""></vin<1.8v<>
High	Vin > 2.2V

Pin Descriptions

PIN #	PIN NAME	TYPE	DESCRIPTION
1	VDDA	PWR	3.3V power for the PLL core.
2	GNDA	PWR	Ground pin for the PLL core.
	10014 10014#	INI	3.3V Input to select operating frequency
3	100M_133M#	IN	See Functionality Table for Definition
4	LUDW DVDM LODW!	IN	Trilevel input to select High BW, Bypass or Low BW mode.
4	HIBW_BYPM_LOBW#	IIN	See PLL Operating Mode Table for Details.
_	OKDWDOD DD#	IN	Notifies device to sample latched inputs and start up on first high assertion, or exit Power Down Mode on
5	CKPWRGD_PD#	IIN	subsequent assertions. Low enters Power Down Mode.
6	GND	PWR	Ground pin.
7	VDDD	DWD	3.3V power for differential input clock (receiver). This VDD should be treated as an analog power rail and
7	VDDR	PWR	filtered appropriately.
8	DIF_IN	IN	0.7 V Differential TRUE input
9	DIF_IN#	IN	0.7 V Differential Complementary Input
10	CMD AO to:	INI	SMBus address bit. This is a tri-level input that works in conjunction with the SMB_A1 to decode 1 of 9 SMBus
10	SMB_A0_tri	IN	Addresses.
11	SMBDAT	I/O	Data pin of SMBUS circuitry, 5V tolerant
12	SMBCLK	IN	Clock pin of SMBUS circuitry, 5V tolerant
40	OMD A4 12	18.1	SMBus address bit. This is a tri-level input that works in conjunction with the SMB_A0 to decode 1 of 9 SMBus
13	SMB_A1_tri	IN	Addresses.
4.4	EDOUT NO	OLIT.	Complementary half of differential feedback output. This pin should NOT be connected to anything outside the
14	FBOUT_NC#	OUT	chip. It exists to provide delay path matching to get 0 propagation delay.
45	EDOLLT NO	OUT	True half of differential feedback output. This pin should NOT be connected to anything outside the chip. It
15	FBOUT_NC	001	exists to provide delay path matching to get 0 propagation delay.
16	GND	PWR	Ground pin.
17	DIF_0	OUT	0.7V differential true clock output
18	DIF_0#	OUT	0.7V differential Complementary clock output
19	VDDIO	PWR	Power supply for differential outputs
20	GND		Ground pin.
	DIF_1	OUT	0.7V differential true clock output
22	DIF_1#	OUT	0.7V differential Complementary clock output
23	DIF_2	OUT	0.7V differential true clock output
24	DIF_2#	OUT	0.7V differential Complementary clock output
25	GND		Ground pin.
26	VDD	PWR	Power supply, nominal 3.3V
27	DIF_3	OUT	0.7V differential true clock output
	DIF_3#	OUT	0.7V differential Complementary clock output
29	DIF_4		0.7V differential true clock output
	DIF_4#	OUT	0.7V differential Complementary clock output
31	VDDIO		Power supply for differential outputs
32	GND		Ground pin.

Pin Descriptions (cont.)

PIN#	PIN NAME	TYPE	DESCRIPTION
33	DIF_5	OUT	0.7V differential true clock output
34	DIF_5#	OUT	0.7V differential Complementary clock output
35	GND	PWR	Ground pin.
36	VDDIO	PWR	Power supply for differential outputs
37	DIF_6	OUT	0.7V differential true clock output
38	DIF_6#	OUT	0.7V differential Complementary clock output
39	DIF_7	OUT	0.7V differential true clock output
40	DIF_7#	OUT	0.7V differential Complementary clock output
41	VDD	PWR	Power supply, nominal 3.3V
42	GND	PWR	Ground pin.
43	DIF_8	OUT	0.7V differential true clock output
44	DIF_8#	OUT	0.7V differential Complementary clock output
45	DIF_9	OUT	0.7V differential true clock output
46	DIF_9#	OUT	0.7V differential Complementary clock output
47	GND	PWR	Ground pin.
48	VDDIO	PWR	Power supply for differential outputs
49	DIF_10	OUT	0.7V differential true clock output
50	DIF_10#	OUT	0.7V differential Complementary clock output
51	VDDIO	PWR	Power supply for differential outputs
52	GND	PWR	Ground pin.
53	DIF_11	OUT	0.7V differential true clock output
54	DIF_11#	OUT	0.7V differential Complementary clock output
55	DIF_12	OUT	0.7V differential true clock output
56	DIF_12#	OUT	0.7V differential Complementary clock output
57	GND	PWR	Ground pin.
58	VDD	PWR	Power supply, nominal 3.3V
59	DIF_13	OUT	0.7V differential true clock output
60	DIF_13#	OUT	0.7V differential Complementary clock output
61	DIF_14	OUT	0.7V differential true clock output
62	DIF_14#	OUT	0.7V differential Complementary clock output
63	VDDIO	PWR	Power supply for differential outputs
64	GND	PWR	Ground pin.

Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the 9ZXL1530. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
3.3V Core Supply Voltage	VDDA, R				4.6	V	1,2
3.3V Logic Supply Voltage	VDD				4.6	V	1,2
I/O Supply Voltage	VDDIO				4.6	V	1,2
Input Low Voltage	V_{IL}		GND-0.5			V	1
Input High Voltage	V_{IH}	Except for SMBus interface			V _{DD} +0.5V	V	1
Input High Voltage	V _{IHSMB}	SMBus clock and data pins			5.5V	V	1
Storage Temperature	Ts		-65		150	°C	1
Junction Temperature	Tj				125	°C	1
Input ESD protection	ESD prot	Human Body Model	2000			V	1

Guaranteed by design and characterization, not 100% tested in production.

Electrical Characteristics-DIF_IN Clock Input Parameters

TA = T_{COM}; Supply Voltage VDD/VDDA = 3.3 V +/-5%, VDDIO = 1.05 to 3.3V +/-5%. See Test Loads for Loading Conditions

Tit = 100 Wi, Cappiy Voltage	Tite 100M, Supply Voltage VBB/VBB/V = 0.0 V 1/ 0/0, VBB/O = 1.00 to 0.0 V 1/ 0/0. Coo 100 to									
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES			
Input Crossover Voltage - DIF_IN	V _{CROSS}	Cross Over Voltage	150		900	mV	1			
Input Swing - DIF_IN	V _{SWING}	Differential value	300			mV	1			
Input Slew Rate - DIF_IN	dv/dt	Measured differentially	0.4		8	V/ns	1,2			
Input Leakage Current	I _{IN}	$V_{IN} = V_{DD}$, $V_{IN} = GND$	-5		5	uA				
Input Duty Cycle	d _{tin}	Measurement from differential wavefrom	45		55	%	1			
Input Jitter - Cycle to Cycle	J_{DIFIn}	Differential Measurement	0		125	ps	1			

¹ Guaranteed by design and characterization, not 100% tested in production.

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 $^{^{2}\,\}mbox{Operation}$ under these conditions is neither implied nor guaranteed.

²Slew rate measured through +/-75mV window centered around differential zero

Electrical Characteristics-Input/Supply/Common Output Parameters

TA = T_{COM}; Supply Voltage VDD/VDDA = 3.3 V +/-5%, VDDIO = 1.05 to 3.3V +/-5%. See Test Loads for Loading Conditions

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
Ambient Operating Temperature	Т _{сом}	Commmercial range	0		70	°C	1
Input High Voltage	V _{IH}	Single-ended inputs, except SMBus, low threshold and tri-level inputs	2		V _{DD} + 0.3	٧	1
Input Low Voltage	V_{IL}	Single-ended inputs, except SMBus, low threshold and tri-level inputs	GND - 0.3		0.8	٧	1
	I _{IN}	Single-ended inputs, $V_{IN} = GND$, $V_{IN} = VDD$	-5		5	uA	1
Input Current	I _{INP}	$\label{eq:VIN} Single-ended inputs \\ V_{IN} = 0 \text{ V; Inputs with internal pull-up resistors} \\ V_{IN} = VDD; Inputs with internal pull-down resistors$	-200		200	uA	1
	F_{ibyp}	V _{DD} = 3.3 V, Bypass mode	33		150	MHz	2
Input Fre quen cy	FipI	$V_{DD} = 3.3 \text{ V}, 100 \text{MHz PLL mode}$	90	100.00	110	MHz	2
	F _{ip1}	V _{DD} = 3.3 V, 133.33MHz PLL mode	120	133.33	147	MHz	2
Pin Inductance	L _{pin}				7	nH	1
	C _{IN}	Logic Inputs, except DIF_IN	1.5		5	pF	1
Capacitance	C_{INDIF_IN}	DIF_IN differential clock inputs	1.5		2.7	pF	1,4
·	C_{OUT}	Output pin capacitance			6	V V UA UA MHz MHz MHz nH pF pF pF rs W V V V MA V rs ns	1
Clk Stabilization	T _{STAB}	From V _{DD} Power-Up and after input clock stabilization or de-assertion of PD# to 1st clock			1	ms	1,2
Input SS Modulation Frequency	f _{MODIN}	Allowable Frequency (Triangular Modulation)	30		33	kHz	1
Tdrive_PD#	t _{DRVPD}	DIF output enable after PD# de-assertion			300	us	1,3
Tfall	t _F	Fall time of control inputs			5	ns	1,2
Trise	t _R	Rise time of control inputs			5	ns	1,2
SMBus Input Low Voltage	V_{ILSMB}				0.8	V	1
SMBus Input High Voltage	V _{IHSMB}		2.1		V _{DDSMB}	V	1
SMBus Output Low Voltage	V _{OLSMB}	@ I _{PULLUP}			0.4	V	1
SMBus Sink Current	I _{PULLUP}	@ V _{OL}	4			mA	1
Nominal Bus Voltage	V_{DDSMB}	3V to 5V +/- 10%	2.7		5.5	V	1
SCLK/SDATA Rise Time	t _{RSMB}	(Max VIL - 0.15) to (Min VIH + 0.15)			1000	ns	1
SCLK/SDATA Fall Time	t _{FSMB}	(Min VIH + 0.15) to (Max VIL - 0.15)			300	ns	1
SMBus Operating Frequency	f _{MINSMB}	Minimum SMBus operating frequency	100			kHz	1,5

¹Guaranteed by design and characterization, not 100% tested in production.

²Control input must be monotonic from 20% to 80% of input swing.

³Time from deassertion until outputs are >200 mV

⁴DIF_IN input

⁵The differential input clock must be running for the SMBus to be active

Electrical Characteristics-DIF 0.7V Low Power Differential Outputs

 $TA = T_{COM}$; Supply Voltage VDD/VDDA = 3.3 V +/-5%, VDDIO = 1.05 to 3.3 V +/-5%. See Test Loads for Loading Conditions

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
Slew rate	Trf	Scope averaging on	1	3	4	V/ns	1, 2, 3
Slew rate matching	∆Trf	Slew rate matching.		7.6	20	%	1, 2, 4
Voltage High	VHigh	Statistical measurement on single-ended signal using oscilloscope math function. (Scope averaging	660	757	850	mV	1
Voltage Low	VLow	on)	-150	16	150	1117	1
Max Voltage	Vmax	Measurement on single ended signal using absolute		857	1150	mV	1
Min Voltage	Vmin	value. (Scope averaging off)	-300	-36		IIIV	1
Vswing	Vswing	Scope averaging off	300			mV	1, 2
Crossing Voltage (abs)	Vcross_abs	Scope averaging off	300	469	550	mV	1,5
Crossing Voltage (var)	Δ-Vcross	Scope averaging off		14	140	mV	1,6

¹Guaranteed by design and characterization, not 100% tested in production. $C_L = 2pF$ with $R_S = 27Ω$ for Zo = 85Ω differential trace impedance.

Electrical Characteristics-Current Consumption

TA = T_{COM}; Supply Voltage VDD/VDDA = 3.3 V +/-5%, VDDIO = 1.05 to 3.3V +/-5%. See Test Loads for Loading Conditions

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
Operating Supply Current	I_{DDVDD}	All outputs active @100MHz, C _L = 2pF;		23	40	mA	1
	I _{DDVDDA/R}	All outputs active @100MHz, $C_L = 2pF$;		15	20	mA	1
	I _{DDVDDIO}	All outputs active @100MHz, C _L = 2pF;		124	150	mA	1
	$I_{DDVDDPD}$	All differential pairs low-low		2.2	4	mA	1
Powerdown Current	I _{DD VDD A/RPD}	All differential pairs low-low		4.9	7	mA	1
	I _{DDVDDIOPD}	All differential pairs low-low		0.16	0.5	mA	1

¹Guaranteed by design and characterization, not 100% tested in production.

² Measured from differential waveform

 $^{^{3}}$ Slew rate is measured through the Vswing voltage range centered around differential 0V. This results in a +/-150mV window around differential 0V.

⁴ Matching applies to rising edge rate for Clock and falling edge rate for Clock#. It is measured using a +/-75mV window centered on the average cross point where Clock rising meets Clock# falling. The median cross point is used to calculate the voltage thresholds the oscilloscope is to use for the edge rate calculations.

⁵ Vcross is defined as voltage where Clock = Clock# measured on a component test board and only applies to the differential rising edge (i.e. Clock rising and Clock# falling).

⁶ The total variation of all Vcross measurements in any particular system. Note that this is a subset of Vcross_min/max (Vcross absolute) allowed. The intent is to limit Vcross induced modulation by setting Δ-Vcross to be smaller than Vcross absolute.

Electrical Characteristics-Skew and Differential Jitter Parameters

TA = T_{COM}; Supply Voltage VDD/VDDA = 3.3 V +/-5%, VDDIO = 1.05 to 3.3V +/-5%. See Test Loads for Loading Conditions

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
CLK_IN, DIF[x:0]	t _{SPO_PLL}	Input-to-Output Skew in PLL mode nominal value @ 25°C, 3.3V	-100	-44	100	ps	1,2,4,5,8
CLK_IN, DIF[x:0]	t _{PD_BYP}	Input-to-Output Skew in Bypass mode nominal value @ 25°C, 3.3V	2.5	3.6	4.5	ns	1,2,3,5,8
CLK_IN, DIF[x:0]	t _{DSPO_PLL}	Input-to-Output Skew Varation in PLL mode across voltage and temperature	-50	-2	50	ps	1,2,3,5,8
CLK_IN, DIF[x:0]	t _{DSPO_BYP}	Input-to-Output Skew Varation in Bypass mode across temperature for a given voltage	-250		250	ps	1,2,3,5,8
CLK_IN, DIF[x:0]	t _{DTE}	Random Differential Tracking error beween two 9ZX devices in Hi BW Mode		3	5	ps (rms)	1,2,3,5,8
CLK_IN, DIF[x:0]	t _{DSSTE}	Random Differential Spread Spectrum Tracking error beween two 9ZX devices in Hi BW Mode		15	75	ps	1,2,3,5,8
DIF{x:0]	t _{SKEW_ALL}	Output-to-Output Skew across all outputs (Common to Bypass and PLL mode)		45	65	ps	1,2,3,8
PLL Jitter Peaking	j _{peak-hibw}	LOBW#_BYPASS_HIBW = 1	0	1.75	2.5	dB	7,8
PLL Jitter Peaking	jpeak-lobw	LOBW#_BYPASS_HIBW = 0	0	0.75	2	dB	7,8
PLL Bandwidth	pll _{HIBW}	LOBW#_BYPASS_HIBW = 1	2	3.33	4	MHz	8,9
PLL Bandwidth	pll_{LOBW}	LOBW#_BYPASS_HIBW = 0	0.7	1.18	1.4	MHz	8,9
Duty Cycle	t _{DC}	Measured differentially, PLL Mode	45	50.4%	55	%	1
Duty Cycle Distortion	t _{DCD}	Measured differentially, Bypass Mode @100MHz	-2	0	2	%	1,10
Jitter, Cycle to cycle	t:	PLL mode		24	50	ps	1,11
onto, cycle to cycle	t _{jcyc-cyc}	Additive Jitter in Bypass Mode		0	50	ps	1,11

Notes for preceding table:

¹ Measured into fixed 2 pF load cap. Input to output skew is measured at the first output edge following the corresponding input.

² Measured from differential cross-point to differential cross-point. This parameter can be tuned with external feedback path, if present.

³ All Bypass Mode Input-to-Output specs refer to the timing between an input edge and the specific output edge created by it.

⁴ This parameter is deterministic for a given device

⁵ Measured with scope averaging on to find mean value.

⁶.t is the period of the input clock

⁷ Measured as maximum pass band gain. At frequencies within the loop BW, highest point of magnification is called PLL jitter peaking.

^{8.} Guaranteed by design and characterization, not 100% tested in production.

⁹ Measured at 3 db down or half power point.

¹⁰ Duty cycle distortion is the difference in duty cycle between the output and the input clock when the device is operated in bypass mode.

¹¹ Measured from differential waveform

Electrical Characteristics-Phase Jitter Parameters

 $TA = T_{COM}; \ Supply \ Voltage \ VDD/VDDA = 3.3 \ V + /-5\%, \ VDDIO = 1.05 \ to \ 3.3 V + /-5\%. \ See \ Test \ Loads \ for \ Loading \ Conditions \ A supply \ Voltage \ VDD/VDDA = 3.3 \ V + /-5\%. \ See \ Test \ Loads \ for \ Loading \ Conditions \ A supply \ Voltage \ VDD/VDDA = 3.3 \ V + /-5\%. \ See \ Test \ Loads \ for \ Loading \ Conditions \ A supply \ Voltage \ VDD/VDDA = 3.3 \ V + /-5\%. \ See \ Test \ Loads \ for \ Loading \ Conditions \ A supply \ Voltage \ VDD/VDDA = 3.3 \ V + /-5\%. \ See \ Test \ Loads \ for \ Loading \ Conditions \ A supply \ Voltage \ VDD/VDDA = 3.3 \ V + /-5\%. \ See \ Test \ Loads \ for \ Loading \ Conditions \ A supply \ Voltage \ VDD/VDDA = 3.3 \ V + /-5\%. \ See \ Test \ Loads \ for \ Loading \ Conditions \ A supply \ Voltage \ VDD/VDDA = 3.3 \ V + /-5\%. \ See \ Test \ Loads \ For \$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	Notes
	t _{iphPCleG1}	PCIe Gen 1		30.1	86	ps (p-p)	1,2,3
	•	PCIe Gen 2 Lo Band 10kHz < f < 1.5MHz		1.0	3	ps (rms)	1,2
	t _{jphPCleG2}	PCIe Gen 2 High Band 1.5MHz < f < Nyquist (50MHz)		1.7	3.1	ps (rms)	1,2
Phase Jitter, PLL Mode	t _{jphPCleG3}	PCIe Gen 3 (PLL BW of 2-4MHz, CDR = 10MHz)		0.38	1	ps (rms)	1,2,4
		QPI & SMI (100MHz or 133MHz, 4.8Gb/s, 6.4Gb/s 12UI)		0.18	0.5	ps (rms)	1,5
	t _{jphQPI_SMI}	QPI & SMI (100MHz, 8.0Gb/s, 12UI)		0.13	0.3	ps (rms)	1,5
		QPI & SMI (100MHz, 9.6Gb/s, 12UI)		0.10	0.2	ps (rms)	1,5
	t _{iphPCleG1}	PCIe Gen 1		0.00	10	ps (p-p)	1,2,3
		PCIe Gen 2 Lo Band 10kHz < f < 1.5MHz		0.01	0.3	ps (rms)	1,2,6
	t _{jphPCleG2}	PCIe Gen 2 High Band 1.5MHz < f < Nyquist (50MHz)		0.00	0.7	ps (rms)	1,2,6
Additive Phase Jitter, Bypass mode	t _{jphPCleG3}	PCIe Gen 3 (PLL BW of 2-4MHz, CDR = 10MHz)		0.00	0.3	ps (rms)	1,2,4,6
Вураво точе		QPI & SMI (100MHz or 133MHz, 4.8Gb/s, 6.4Gb/s 12UI)		0.12	0.3	ps (rms)	1,5,6
	t _{jphQPI_SMI}	QPI & SMI (100MHz, 8.0Gb/s, 12UI)		0.00	0.1	ps (rms)	1,5,6
		QPI & SMI (100MHz, 9.6Gb/s, 12UI)		0.00	0.1	ps (rms)	1,5,6

¹ Applies to all outputs.

² See http://www.pcisig.com for complete specs

³ Sample size of at least 100K cycles. This figures extrapolates to 108ps pk-pk @ 1M cycles for a BER of 1-12.

⁴ Subject to final ratification by PCI SIG.

⁵ Calculated from Intel-supplied Clock Jitter Tool v 1.6.4

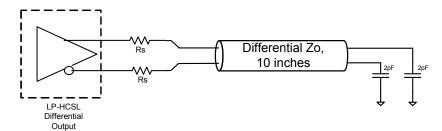
⁶ For RMS figures, additive jitter is calculated by solving the following equation: (Additive jitter)² = (total jitter)² - (input jitter)²

Test Loads

Differential Output Terminations

DIF Zo (Ω)	Rs (Ω)
100	33
85	27

9ZXL Differential Test Loads



Clock Periods-Differential Outputs with Spread Spectrum Disabled

					Measurement	Window				
	Center	1 Clock	1us	0.1s	0.1s	0.1s	1us	1 Clock		
SSC OFF	Freq. MHz	-c2c jitter AbsPer Min	-SSC Short-Term Average Min	- ppm Long-Term Average Min	0 ppm Period Nominal	+ ppm Long-Term Average Max	+SSC Short-Term Average Max	+c2c jitter AbsPer Max	Units	Notes
DIF	100.00	9.94900		9.99900	10.00000	10.00100		10.05100	ns	1,2,3
Dii	133.33	7.44925		7.49925	7.50000	7.50075		7.55075	ns	1,2,4

Clock Periods-Differential Outputs with Spread Spectrum Enabled

					Vle asure ment	Window				
	Center	1 Clock	1us	0.1s	0.1s	0.1s	1us	1 Clock		
SSC ON	Freq. MHz	-c2c jitter AbsPer Min	-SSC Short-Term Average Min	- ppm Long-Term Average Min	0 ppm Period Nominal	+ ppm Long-Term Average Max	+SSC Short-Term Average Max	+c2c jitter AbsPer Max	Units	Notes
DIF	99.75	9.94906	9.99906	10.02406	10.02506	10.02607	10.05107	10.10107	ns	1,2,3
	133.00	7.44930	7.49930	7.51805	7.51880	7.51955	7.53830	7.58830	ns	1,2,4

Notes:

¹ Guaranteed by design and characterization, not 100% tested in production.

² All Long Term Accuracy specifications are guaranteed with the assumption that the input clock complies with CK420BQ/CK410B+ accuracy requirements (+/-100ppm). The 9ZXL1530 itself does not contribute to ppm error.

 $^{^{\}rm 3}$ Driven by SRC output of main clock, 100 MHz PLL Mode or Bypass mode

⁴ Driven by CPU output of main clock, 133 MHz PLL Mode or Bypass mode

General SMBus Serial Interface Information

How to Write

- · Controller (host) sends a start bit
- · Controller (host) sends the write address
- IDT clock will acknowledge
- Controller (host) sends the beginning byte location = N
- IDT clock will acknowledge
- Controller (host) sends the byte count = X
- IDT clock will acknowledge
- Controller (host) starts sending Byte N through Byte N+X-1
- IDT clock will acknowledge each byte one at a time
- Controller (host) sends a Stop bit

	Index Block Write Operation										
Controll	er (Host)		IDT (Slave/Receiver)								
Т	starT bit										
Slave A	Address										
WR	WRite										
			ACK								
Beginning	g Byte = N										
			ACK								
Data Byte	Count = X										
			ACK								
Beginnin	g Byte N										
			ACK								
0		×									
0		X Byte	0								
0		æ	0								
			0								
Byte N	+ X - 1										
			ACK								
Р	stoP bit										

How to Read

- · Controller (host) will send a start bit
- Controller (host) sends the write address
- IDT clock will acknowledge
- Controller (host) sends the beginning byte location = N
- IDT clock will acknowledge
- Controller (host) will send a separate start bit
- Controller (host) sends the read address
- IDT clock will acknowledge
- IDT clock will send the data byte count = X
- IDT clock sends Byte N+X-1
- IDT clock sends Byte 0 through Byte X (if X_(H) was written to Byte 8)
- Controller (host) will need to acknowledge each byte
- Controller (host) will send a not acknowledge bit
- · Controller (host) will send a stop bit

	Index Block Read Operation						
Cor	troller (Host)		IDT (Slave/Receiver)				
Т	starT bit						
SI	ave Address						
WR	WRite						
			ACK				
Begi	nning Byte = N						
			ACK				
RT	Repeat starT						
SI	ave Address						
RD	ReaD						
			ACK				
			Data Byte Count=X				
	ACK						
			Beginning Byte N				
	ACK						
		<u>e</u>	0				
	0	X Byte	0				
	0	×	0				
	0						
			Byte N + X - 1				
N	Not acknowledge						
Р	stoP bit						

9ZXL1530 SMB us Addressing

SMB_A(1:0)_tri	Address (Rd/Wrt bit = 0) (Hex)
00	D8
OM	DA
01	DE
M0	C2
MM	C4
M1	C6
10	CA
1M	CC
11	CE

SMBusTable: PLL Mode, and Frequency Select Register

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Byte	90 Pin#	Name	Control Function	Type	0	1	Default
Bit 7	4	PLL Mode 1	PLL Operating Mode Rd back 1	R	See PLL Operating Mode		Latch
Bit 6	4	PLL Mode 0	PLL Operating Mode Rd back 0	R	Readba	ck Table	Latch
Bit 5			Reserved				
Bit 4	61/62	DIF_14_En	Output Enable	RW	Low/Low	Enable	1
Bit 3	59/60	DIF_13_En	Output Enable	RW	Low/Low	Enable	1
Bit 2			Reserved				0
Bit 1		Reserved					0
Bit 0	3	100M_133M#	Frequency Select Readback	R	133MHz	100MHz	Latch

SMBusTable: Output Control Register

Byte 1	Pin #	Name	Control Function	Туре	0	1	Default
Bit 7	39/40	DIF_5_En	Output Enable	RW	Low/Low	Enable	1
Bit 6			Reserved				1
Bit 5	29/30	DIF_4_En	Output Enable	RW			1
Bit 4	29/30	DIF_3_En	Output Enable	RW			1
Bit 3	23/24	DIF_2_En	Output Enable	RW	Low/Low	Enable	1
Bit 2	21/22	DIF_1_En	Output Enable	RW			1
Bit 1	17/18	DIF_0_En	Output Enable	RW			1
Bit 0			Reserved		•	•	1

SMBusTable: Output Control Register

Byte 2	Pin #	Name	Control Function	Type	0	1	Default
Bit 7	55/56	DIF_12_En	Output Enable	RW	Low/Low	Enable	1
Bit 6	53/54	DIF_11_En	Output Enable	RW			1
Bit 5	49/50	DIF_10_En	Output Enable	RW			1
Bit 4			Reserved				1
Bit 3	45/46	DIF_9_En	Output Enable	RW			1
Bit 2	43/44	DIF_8_En	Output Enable	RW			1
Bit 1	39/40	DIF_7_En	Output Enable	RW			1
Bit 0	37/38	DIF_6_En	Output Enable	RW			1

SMBusTable: Reserved Register

Byte 3	Pin #	Name	Control Function	Туре	0	1	Default		
Bit 7			Reserved				0		
Bit 6			Reserved						
Bit 5			Reserved						
Bit 4			Reserved						
Bit 3			Reserved				0		
Bit 2			Reserved						
Bit 1		Reserved							
Bit 0			Reserved				0		

SMBusTable: Reserved Register

Byte	e 4	Pin #	Name	Control Function	Туре	0	1	Default	
Bit 7				Reserved				0	
Bit 6				Reserved					
Bit 5				Reserved					
Bit 4			Reserved						
Bit 3				Reserved					
Bit 2				Reserved					
Bit 1			Reserved					0	
Bit 0				Reserved				0	

SMBusTable: Vendor & Revision ID Register

Byte	5 Pin #	Name	Control Function	Туре	0	1	Default
Bit 7	· -	RID3		R	B rev = 0001		Х
Bit 6	-	RID2	REVISION ID	R			Х
Bit 5	-	RID1		R	D lev	Х	
Bit 4	-	RID0		R		Х	
Bit 3	-	VID3		R	-	-	0
Bit 2	-	VID2	VENDOD ID	R	-	-	0
Bit 1	-	VID1	VENDOR ID	R	-	-	0
Bit 0	-	VID0		R	-	-	1

SMBusTable: DEVICE ID

Byte	6 Pin #	Name	Control Function	Туре	0	1	Default
Bit 7	-		Device ID 7 (MSB)	R			1
Bit 6	-	Device ID 6		R	1		Х
Bit 5	-		Device ID 5	R			Х
Bit 4	-		Device ID 4	R	1530 is 153 decimal or 99 Hex		Х
Bit 3	-		Device ID 3	R			Χ
Bit 2	-		Device ID 2	R			0
Bit 1	-		Device ID 1	R			0
Bit 0	-		Device ID 0	R	1		1

SMBusTable: Byte Count Register

Byte	e 7	Pin #	Name	Control Function	Туре	0	1	Default
Bit 7			Reserved					0
Bit 6				Reserved				0
Bit 5				Reserved				0
Bit 4			BC4		RW			0
Bit 3			BC3	Writing to this register configures how	RW	Default value	is 8 hex, so 9	1
Bit 2			BC2	Writing to this register configures how	RW	bytes (0 to 8) v	vill be read back	0
Bit 1			BC1	many bytes will be read back.	RW	by default.		0
Bit 0			BC0		RW			0

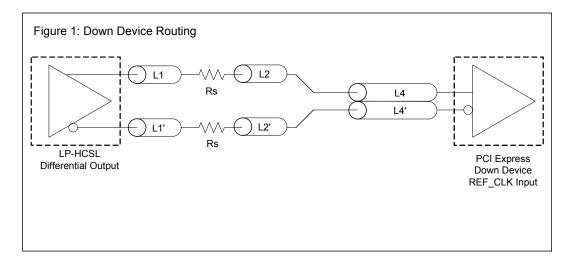
SMBusTable: Reserved Register

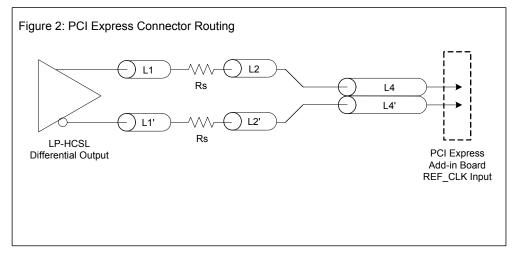
Byte 8	Pin #	Name	Control Function	Type	0	1	Default	
Bit 7			Reserved				0	
Bit 6			Reserved				0	
Bit 5			Reserved				0	
Bit 4		Reserved					0	
Bit 3			Reserved					
Bit 2		Reserved						
Bit 1		Reserved					0	
Bit 0			Reserved					

DIF Reference Clock							
Common Recommendations for Differential Routing	Dimension or Value	Unit	Figure				
L1 length, route as non-coupled 50ohm trace	0.5 max	inch	1				
L2 length, route as non-coupled 50ohm trace	0.2 max	inch	1				
L3 length, route as non-coupled 50ohm trace	0.2 max	inch	1				
Rs (100 ohm differential traces)	33	ohm	1				
Rs (85 ohm differential traces)	27	ohm	1				

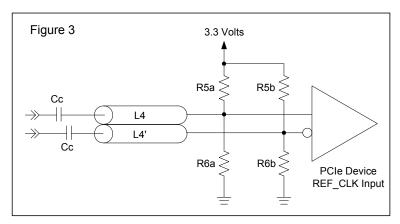
Down Device Differential Routing			
L4 length, route as coupled microstrip 100ohm differential trace	2 min to 16 max	inch	1
L4 length, route as coupled stripline 100ohm differential trace	1.8 min to 14.4 max	inch	1

Differential Routing to PCI Express Connector		
L4 length, route as coupled microstrip 100ohm differential trace 0.25 to 14 ma	x inch	2
L4 length, route as coupled stripline 100ohm differential trace 0.225 min to	12.6 max inch	2





Cable Connected AC Coupled Application (Figure 3)							
Component	Value	Note					
R5a, R5b	8.2K 5%						
R6a, R6b	1K 5%						
Сс	0.1 μF						
Vcm	0.350 volts						



Marking Diagram

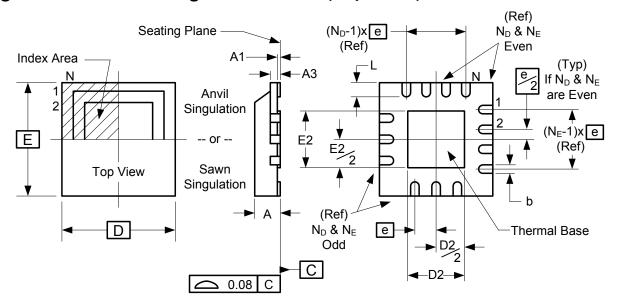


ICS 9ZXL1530BKL LOT COO YYWW

Notes:

- 1. "L" denotes RoHS compliant package.
- 2. "COO": country of origin.
- 3. YYWW is the last two digits of the year and week that the part was assembled.

Package Outline and Package Dimensions (64-pin MLF)



	Millim	eters	
Symbol	Min	Max	
Α	0.8	1.0	
A1	0	0.05	
A3	0.25 Re	ference	
b	0.18	0.30	
е	0.50 BASIC		
D x E BASIC	9.00 >	9.00	
D2 MIN./MAX.	6.00	6.25	
E2 MIN./MAX.	6.00	6.25	
L MIN./MAX.	0.30	0.50	
N	64		
N_D	16		
N _E	16		

Ordering Information

Part / Order Number	Marking	Shipping Packaging	Package	Temperature
9ZXL1530BKLF	see page 16	Trays	64-pin MLF	0 to +70° C
9ZXL1530BKLFT		Tape and Reel	64-pin MLF	0 to +70° C

[&]quot;LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

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[&]quot;B" is the device revision designator (will not correlate with the datasheet revision).

Revision History

Rev.	Issuer	Issue Date	Description	Page #
А	RDW	4/18/2011	 Update Electrical Tables with Characterization Data and corrected minor typos Added Test Load information Updated ordering information and also corrected table to show bulk parts ship in trays, not tubes. Added mark information. 	5-10, 15,16
В	RDW	12/8/2011	Updated tDSPO_BYP parameter by removing duplicate entry Updated REV ID in byte 5 to indicate B rev	8, 13
С	RDW	3/12/2012	Corrected minor typos, Standardized output type references to LP-HCSL. Added pin description for pin 37.	1,4,9,10, 14
D	RDW	11/20/2015	Updated QPI references to QPI/UPI Updated DIF_IN table to match PCI SIG specification, no silicon change	1,5

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